



Substitute for form 1449/PTO
(Revised 07/2005)

INFORMATION DISCLOSURE STATEMENT BY APPLICANT

(Use as many sheets as necessary)

Sheet 1 of 3

Complete if Known

Application Number 10/706,863
Filing Date November 12, 2003
First Named Inventor Iwabuchi et al.
Group Art Unit 2826
Examiner Name Quach, Tuan N.
Attorney Docket Number 035576/271460

U. S. PATENT DOCUMENTS

Examiner Initials*	Cite No.	Document Number Number - Kind Code (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages of Relevant Figures Appear
TQ	13	US-2002/0020327	02-21-2002	Hayashi, et al.	
	14	US-2002/0098279 A1	07-25-2002	Lyu, et al.	
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Examiner Signature	<u>/Tuan Quach/</u>	Date Considered	<u>05/26/2006</u>
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Examiner Name	Quach, Tuan N.				
Sheet	2	of	3	Attorney Docket Number	035576/271460

FOREIGN PATENT DOCUMENTS						
Examiner Initials	Cite No.	Foreign Patent Document Country Code - Number Kind Code (if known)	Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	English Language Translation Attached
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Examiner Signature	/Tuan Quach/	Date Considered	05/26/2006
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TQ	58	WO 03/088344	10-23-2003	Honeywell International, Inc.		

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Examiner Initials*	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city and-or country where published.	English Language Translation Attached
TQ	59	BURKETT ET AL., "Synthesis Of Hybrid Inorganic-Organic Mesoporous Silica By Co-Condensation Of Siloxane And Organosiloxane Precursors," <u>J. Chem. Soc. Chem. Commun.</u> , 1996, 1367-1368.	
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